

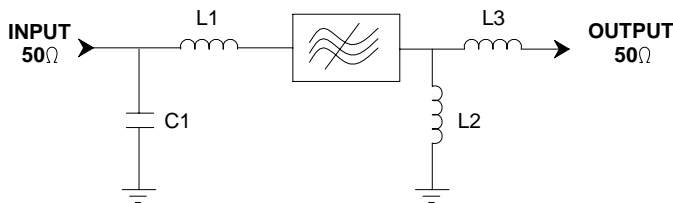
Specifications

Parameter	Unit	Minimum	Typical	Maximum
Center Frequency	MHz	114.8	115	115.2
Insertion Loss	dB	-	27.4	28
2 dB Bandwidth	MHz	6.1	6.16	-
35 dB Bandwidth	MHz	-	6.78	6.8
Absolute Delay	usec	-	4.367	4.5
Passband Variation	dB	-	1.4	2
Ultimate Rejection	dB	50	51	-
Substrate Material		112LT		
Ambient Temperature	°C	25		
Package Size		DIP3512 (35.0x12.8x4.7mm ³)		

Notes:

1. All specifications are based on the test circuit shown
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
4. This is the optimum impedance in order to achieve the performance show


Matching Configuration



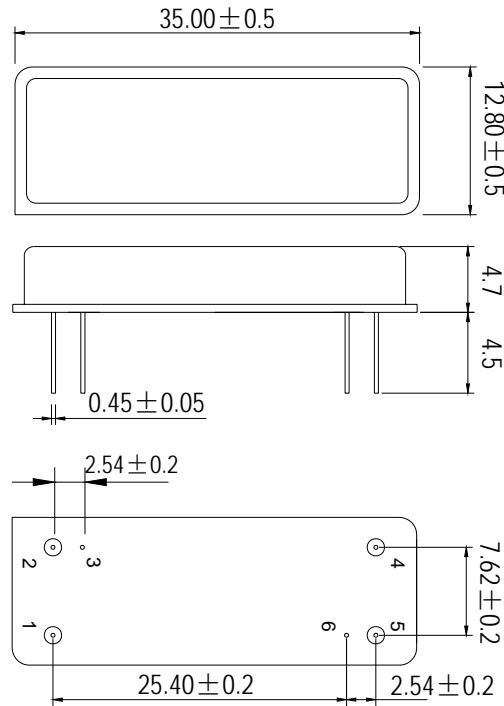
L1=47nH L2=L3=33nH C1=82PF

Source/Load Impedance=50 ohm

Notes - Component values may change depending on board layout.

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Package Dimension

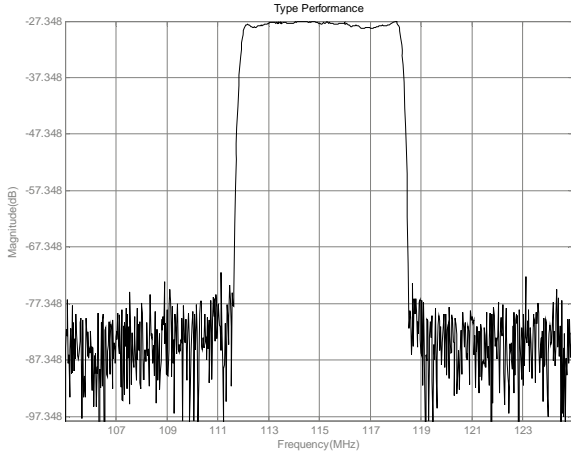


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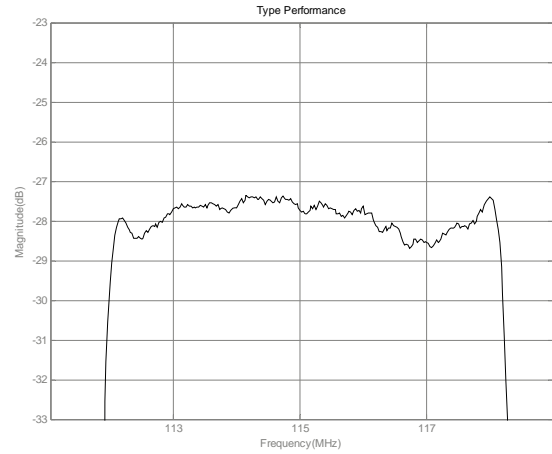
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Typical Performance

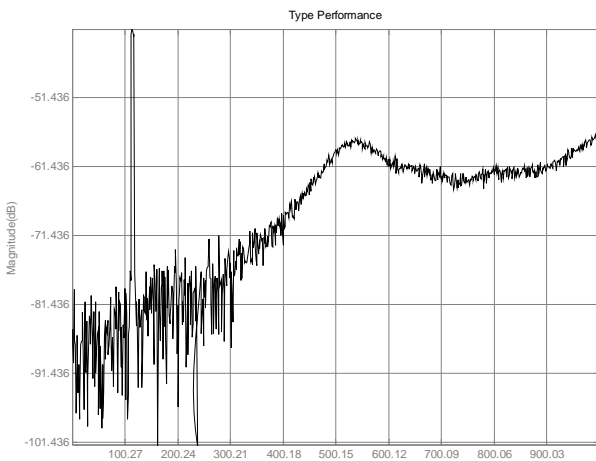
Frequency Respond



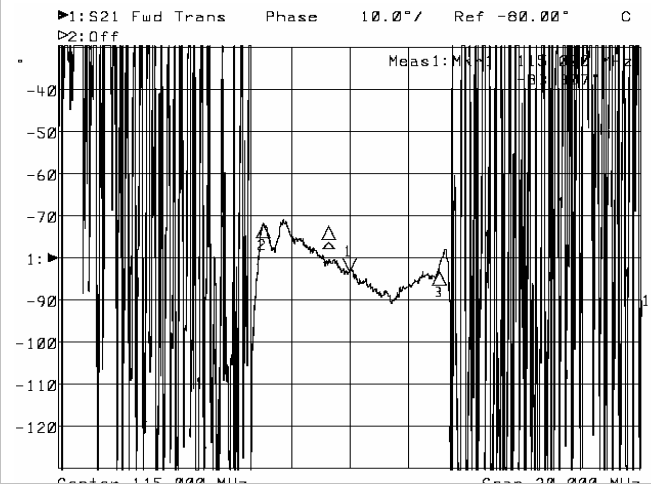
Passband Respond



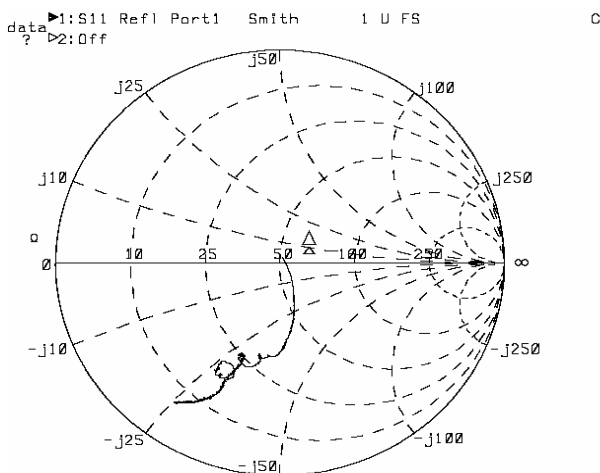
Wideband Respond



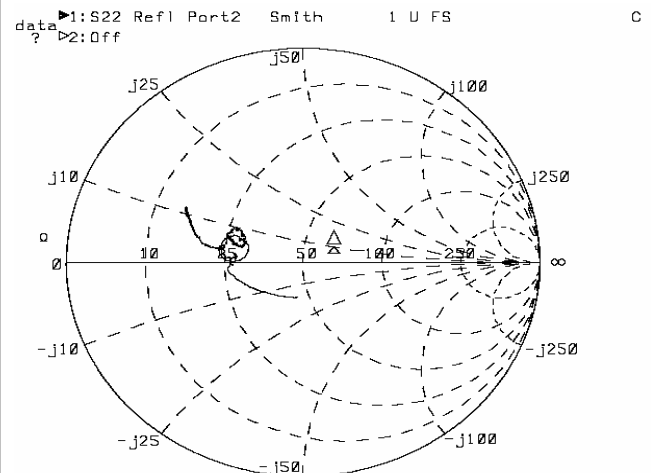
Phase Linearity



Smith Chart S11



Smith Chart S22



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